

SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER

FEATURES

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | Cathode |
| 2 | Anode |



Top View
Marking Code: U2AB~U2MB
Simplified outline SMBF symbol

MECHANICAL DATA

- Case: SMBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 57mg / 0.002oz

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

- Ratings at 25 °C ambient temperature unless otherwise specified.
- Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

| PARAMETER | SYMBOLS | US2ABF | US2BBF | US2DBF | US2GBF | US2JBF | US2KBF | US2MBF | Units |
|---|--------------------------------------|--------|--------|------------|--------|--------|--------|--------|-------|
| Maximum Repetitive Peak Reverse Voltage | V _{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS voltage | V _{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC Blocking Voltage | V _{DC} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum Average Forward Rectified Current at Ta = 40 °C | I _{F(AV)} | | | | | 2 | | | A |
| Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method) | I _{FSM} | | | 55 | | | 50 | | A |
| Maximum Instantaneous Forward Voltage at 2 A | V _F | | 1.0 | | 1.3 | | 1.6 | | V |
| Maximum DC Reverse Current Ta = 25 °C at Rated DC Blocking Voltage Ta = 125 °C | I _R | | | 5 | 100 | | | | µA |
| Typical Junction Capacitance ¹⁾ | C _j | | | 60 | | | | | pF |
| Maximum Reverse Recovery Time ²⁾ | t _{rr} | | 50 | | 75 | | | | ns |
| Typical Thermal Resistance ³⁾ | R _{θJA} R _{θJL} | | | 60 | 20 | | | | °C/W |
| Operating and Storage Temperature Range | T _j , T _{stg} | | | -55 ~ +150 | | | | | °C |

NOTES:

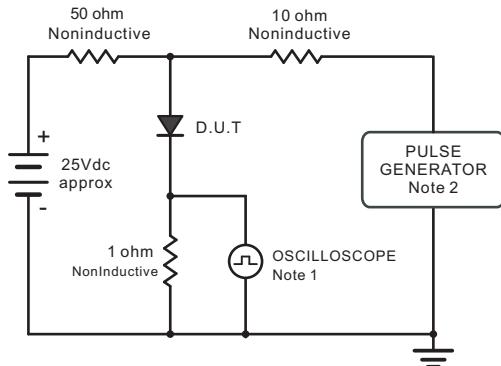
1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

2) Measured with IF = 0.5 A, IR = 1 A, Irr = 0.25 A P.C.B. mounted with 0.5 X 0.5" (12.7 X 12.7 mm²) copper pad areas.

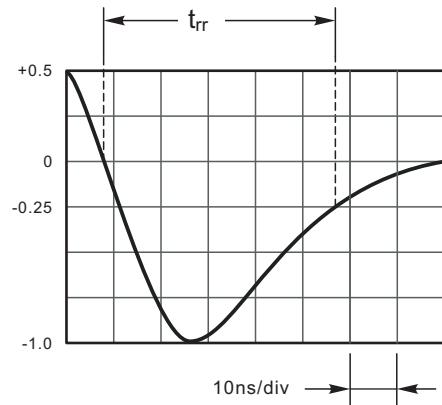
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RATINGS AND CHARACTERISTICS OF US2ABF - US2MBF

Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm, 22pF.
2. Ries Time =10ns, max.
Source Impedance = 50 ohms.



Set time Base for 10ns/div

Fig.2 Maximum Average Forward Current Rating

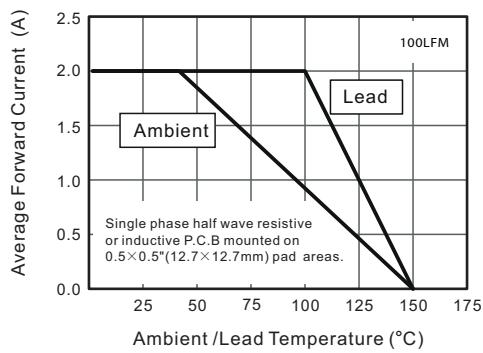


Fig.3 Typical Reverse Characteristics

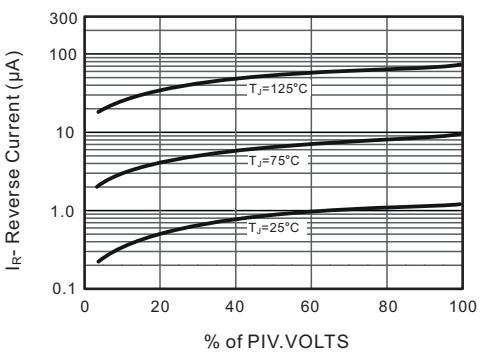


Fig.3 Typical Instantaneous Forward Characteristics

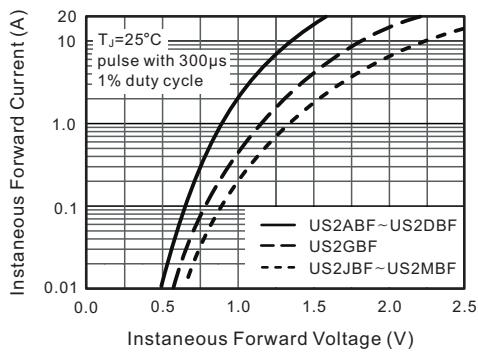
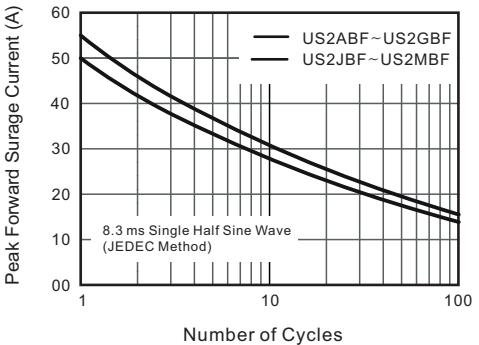


Fig.4 Maximum Non-Repetitive Peak Forward Surge Current

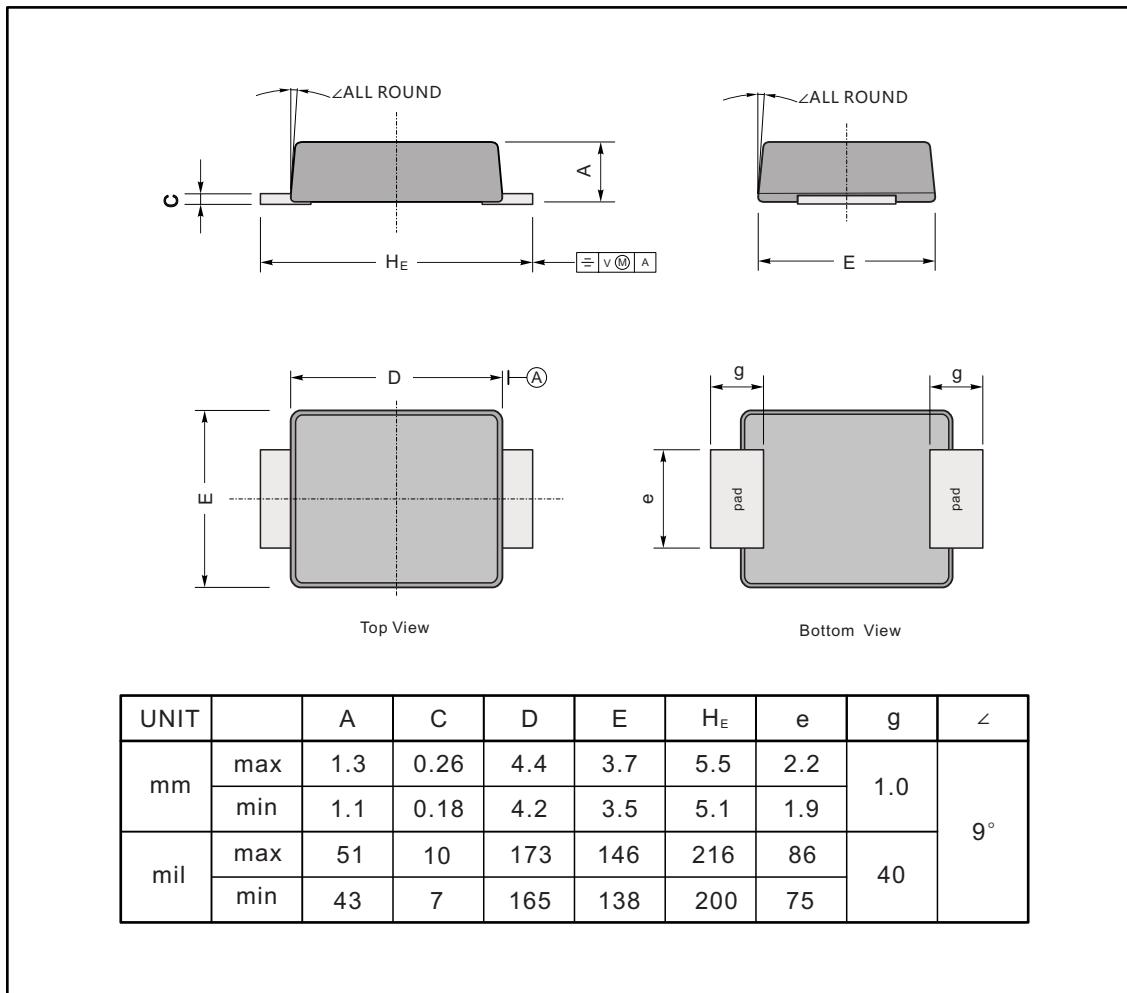


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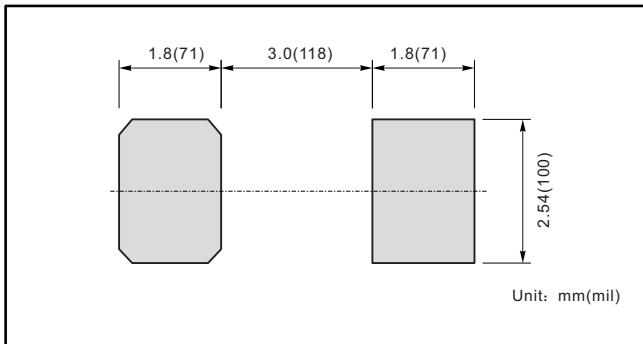
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMBF



The recommended mounting pad size



Marking

| Type number | Marking code |
|-------------|--------------|
| US2ABF | U2AB |
| US2BBF | U2BB |
| US2DBF | U2DB |
| US2GBF | U2GB |
| US2JBF | U2JB |
| US2KBF | U2KB |
| US2MBF | U2MB |

Disclaimer

All product, product specifications and data are subject to change without notice to improve reliability, function or design or otherwise.